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**AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**LISTING OF CLAIMS:**

Claim 1 (currently amended): A laminated ceramic electronic component comprising:

a laminated member including a plurality of stacked ceramic layers having a first ceramic layer and a second ceramic layer which is thinner than said first ceramic layer; and

wiring conductors provided for a certain layer of said ceramic layers and including a via-hole conductor extending through said certain layer and a conductor extending along the principal surface of said certain layer; wherein

~~said via-hole conductors of different ceramic layers includes first and second via-hole conductors having have different sectional sizes; and~~

~~the aspect ratio expressed by H/D is within the range of approximately 0.1 to approximately 3.0, wherein H and D represent the height and radial length for each of said via-hole conductors, respectively.~~

Claim 2 (currently amended): A laminated ceramic electronic component according to Claim 1, wherein ~~said~~a first via-hole conductor extends through said first ceramic layer, ~~said~~a second via-hole conductor extends through said second ceramic layer, and the sectional size of said first via-hole conductor is larger than that of said second via-hole conductor.

Claim 3 (original): A laminated ceramic electronic component according to Claim 2, wherein, of all said via-hole conductors, the sectional size of the via-hole conductor

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extending through the thicker ceramic layer is larger than that of the via-hole conductor extending through the thinner ceramic layer.

**Claim 4 (original): A laminated ceramic electronic component according to Claim 3, wherein a plurality of said via-hole conductors extending through the same ceramic layer have substantially the same sectional size.**

**Claim 5 (canceled).**

**Claim 6 (original): A laminated ceramic electronic component according to Claim 1, wherein said plurality of ceramic layers have substantially the same dielectric constant.**

**Claims 7-12 (canceled).**

**Claim 13 (currently amended): An electronic device comprising:  
a laminated ceramic electronic component; and  
a wiring board for mounting said laminated ceramic electronic component thereon;**

**wherein said laminated ceramic electronic component includes a laminated member having a plurality of stacked ceramic layers including a first ceramic layer and a second ceramic layer that is thinner than said first ceramic layer;**

**wherein wiring conductors are provided for a specific ceramic layer and include a via-hole conductor extending through said specific ceramic layer and a conductor film extending along the principal surface of said specific ceramic layer; and**

**said via-hole conductors of different ceramic layers includes first and second via-hole conductors having have different sectional sizes; and**

**the aspect ratio expressed by H/D is within the range of approximately 0.1 to**

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approximately 3.0, wherein H and D represent the height and radial length for each of said via-hole conductors, respectively.

Claim 14 (currently amended): An electronic device according to Claim 13, wherein said-a first via-hole conductor extends through said first ceramic layer, said-a second via-hole conductor extends through said second ceramic layer, and the sectional size of said first via-hole conductor is larger than that of said second via-hole conductor.

Claim 15 (original): An electronic device according to Claim 14, wherein, of all said via-hole conductors, the sectional size of the via-hole conductor extending through the thicker ceramic layer is larger than that of the via-hole conductor extending through the thinner ceramic layer.

Claim 16 (original): An electronic device according to Claim 15, wherein a plurality of said via-hole conductors extending through the same ceramic layer have substantially the same sectional size.

Claim 17 (canceled).

Claim 18 (original): An electronic device according to Claim 14, wherein said plurality of ceramic layers have substantially the same dielectric constant.